

5V, Single Chip WAN Multi-Mode Serial Transceiver

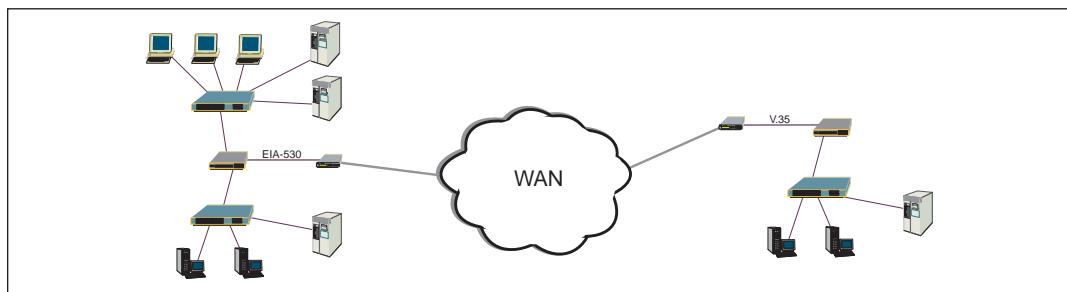
- Interface Modes Supported:
 - ✓ RS-232 (v.28) ✓ X.21/RS-422 (v.11)
 - ✓ EIA-530 (v.10 & v.11) ✓ EIA-530A (v.10 & v.11)
 - ✓ RS-449 (v.10 & v.11) ✓ V.35 (v.35 & v.28)
 - ✓ V.36 (v.10 & v.11) ✓ RS-485 (unterminated v.11)
- Software Selectable Protocol
- Highest Differential Transmission Rates at over 20Mbps
- +5V Only Operation
- Seven (7) Drivers and Seven (7) Receivers
- Driver and Receiver Tri-state Control
- Internal Transceiver Termination Resistors for V.11 and V.35 Protocols
- Loopback Self-Test Mode
- Improved ESD Tolerance for Analog I/Os
- Compliant to NET1/2 and TBR2 Physical Layer Requirements
- Used in WAN Serial Ports in Routers, Switches, DSU/CSU's and other Access Devices



DESCRIPTION

The **SP506** is a monolithic IC that supports eight (8) popular serial interface standards for DTE to DCE connectivity. The **SP506** is pin-to-pin compatible to our SP505 multi-protocol transceiver but with faster throughput. The seven (7) drivers and seven (7) receivers can transmit and receive signals at 20Mbps. As with the SP505, the **SP506** requires no additional external components for compliant operation for all of the eight (8) modes of operation. All necessary termination is integrated within the **SP506** and is switchable when V.35 drivers, V.35 receivers, and V.11 receivers are used. The **SP506** can operate as either a DTE or DCE.

Additional features with the **SP506** include internal loopback that can be initiated in either single-ended or differential modes. While in loopback mode, driver outputs are internally connected to receiver inputs creating an internal signal path convenient for diagnostic testing. This eliminates the need for an external loopback plug. The **SP506** also includes a latch enable pin with the driver and receiver address decoder. Tri-state ability for the driver and receiver outputs is controlled by supplying a 4-bit word into the address decoder. Seven (7) drivers and one (1) receiver in the **SP506** include separate enable pins for added convenience.



ABSOLUTE MAXIMUM RATINGS

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections of the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

V_{CC}+7V

Input Voltages:

Logic.....-0.3V to (V_{CC} +0.5V)

Drivers.....-0.3V to (V_{CC} +0.5V)

Receivers.....±15.5V

Output Voltages:

Logic.....-0.3V to (V_{CC} +0.5V)

Drivers.....±15V

Receivers.....-0.3V to (V_{CC} +0.5V)

Storage Temperature.....-65°C to +150°C

Power Dissipation per package

80-pin QFP (derate 18.3mW/°C above +70°C)...1500mW

STORAGE CONSIDERATIONS

Due to the relatively large package size of the 80-pin quad flat-pack, storage in a low humidity environment is preferred. Large high density plastic packages are moisture sensitive and should be stored in Dry Vapor Barrier Bags. Prior to usage, the parts should remain bagged and stored below 40°C and 60%RH. If the parts are removed from the bag, they should be used within 48 hours or stored in an environment at or below 20%RH. If the above conditions cannot be followed, the parts should be baked for four hours at 125°C in order to remove moisture prior to soldering. Sipex ships the 80-pin QFP in Dry Vapor Barrier Bags with a humidity indicator card and desiccant pack. The humidity indicator should be below 30%RH.

SPECIFICATIONS

$T_A = +25^\circ\text{C}$ and $V_{CC} = +4.75\text{V}$ to $+5.25\text{V}$ unless otherwise noted.

| | MIN. | TYP. | MAX. | UNITS | CONDITIONS |
|-------------------------|-----------|------|-----------|------------------------|---|
| LOGIC INPUTS | | | | | |
| V_{IL} | 2.0 | | 0.8 | Volts | |
| V_{IH} | | | | Volts | |
| LOGIC OUTPUTS | | | | | |
| V_{OL} | 2.4 | | 0.4 | Volts | $I_{OUT} = -3.2\text{mA}$ |
| V_{OH} | | | | Volts | $I_{OUT} = 1.0\text{mA}$ |
| V.28 DRIVER | | | | | |
| DC Parameters | | | | | |
| Outputs | | | | | |
| Open Circuit Voltage | ± 5.0 | | ± 15 | Volts | per Figure 1 |
| Loaded Voltage | | | ± 15 | Volts | per Figure 2 |
| Short-Circuit Current | 300 | | ± 100 | mA | per Figure 4 |
| Power-Off Impedance | | | | Ω | per Figure 5 |
| AC Parameters | | | | | $V_{CC} = +5\text{V}$ for AC parameters |
| Outputs | | | | | |
| Transition Time | | | 1.5 | μs | per Figure 6; +3V to -3V |
| Instantaneous Slew Rate | | | 30 | $\text{V}/\mu\text{s}$ | per Figure 3 |
| Propagation Delay | | | | | |
| t_{PHL} | 0.5 | 1 | 5 | μs | |
| t_{PLH} | 0.5 | 1 | 5 | μs | |
| Max. Transmission Rate | 120 | 230 | | kbps | |
| V.28 RECEIVER | | | | | |
| DC Parameters | | | | | |
| Inputs | | | | | |
| Input Impedance | 3 | | 7 | $k\Omega$ | per Figure 7 |
| Open-Circuit Bias | | | $+2.0$ | Volts | per Figure 8 |
| HIGH Threshold | 0.8 | 1.7 | 3.0 | Volts | |
| LOW Threshold | | 1.2 | | Volts | |
| AC Parameters | | | | | $V_{CC} = +5\text{V}$ for AC parameters |
| Propagation Delay | | | | | |
| t_{PHL} | 50 | 100 | 500 | ns | |
| t_{PLH} | 50 | 100 | 500 | ns | |

SPECIFICATIONS

$T_A = +25^\circ\text{C}$ and $V_{CC} = +4.75\text{V}$ to $+5.25\text{V}$ unless otherwise noted.

| | MIN. | TYP. | MAX. | UNITS | CONDITIONS |
|--|-------------|------|--------------|---------------|---|
| V.28 RECEIVER (continued) AC Parameters (cont.) | | | | | |
| Max. Transmission Rate | 120 | 230 | | kbps | |
| V.10 DRIVER DC Parameters | | | | | |
| Outputs | | | | | |
| Open Circuit Voltage | ± 4.0 | | | Volts | per Figure 9 |
| Test-Terminated Voltage | $0.9V_{OC}$ | | | Volts | per Figure 10 |
| Short-Circuit Current | | | ± 6.0 | mA | per Figure 11 |
| Power-Off Current | | | ± 150 | μA | per Figure 12 |
| AC Parameters | | | ± 100 | | $V_{CC} = +5\text{V}$ for AC parameters |
| Outputs | | | | | |
| Transition Time | | | 200 | ns | per Figure 13; 10% to 90% |
| Propagation Delay | | | | | |
| t_{PHL} | 50 | 100 | 500 | ns | |
| t_{PLH} | 50 | 100 | 500 | ns | |
| Max. Transmission Rate | 120 | | | kbps | |
| V.10 RECEIVER DC Parameters | | | | | |
| Inputs | | | | | |
| Input Current | -3.25 | | | mA | per Figures 14 and 15 |
| Input Impedance | 4 | | | $k\Omega$ | |
| Sensitivity | | | ± 3.25 | Volts | |
| AC Parameters | | | ± 0.3 | | $V_{CC} = +5\text{V}$ for AC parameters |
| Propagation Delay | | | | | |
| t_{PHL} | 50 | 120 | 250 | ns | |
| t_{PLH} | 50 | 120 | 250 | ns | |
| Max. Transmission Rate | 120 | | | kbps | |
| V.11 DRIVER DC Parameters | | | | | |
| Outputs | | | | | |
| Open Circuit Voltage | ± 2.0 | | | Volts | per Figure 16 |
| Test Terminated Voltage | $0.5V_{OC}$ | | | Volts | per Figure 17 |
| Balance | | | ± 5.0 | Volts | |
| Offset | | | $0.67V_{OC}$ | Volts | per Figure 17 |
| Short-Circuit Current | | | ± 0.4 | Volts | per Figure 17 |
| Power-Off Current | | | ± 3.0 | mA | per Figure 18 |
| AC Parameters | | | ± 150 | μA | per Figure 19 |
| Outputs | | | ± 100 | | $V_{CC} = +5\text{V}$ for AC parameters |
| Transition Time | | | | | |
| Propagation Delay | | | 20 | ns | per Figures 21 and 36; 10% to 90% |
| t_{PHL} | 50 | 65 | 85 | ns | per Figures 33 and 36, $C_L = 50\text{pF}$ |
| t_{PLH} | 50 | 65 | 85 | ns | per Figures 33 and 36, $C_L = 50\text{pF}$ |
| Differential Skew | | 10 | 20 | ns | per Figures 33 and 36, $C_L = 50\text{pF}$ |
| Max. Transmission Rate | 20 | | | Mbps | per Figure 33, $C_L = 50\text{pF}$ $f_{IN} = 10\text{MHz}$ |
| V.11 RECEIVER DC Parameters | | | | | |
| Inputs | | | | | |
| Common Mode Range | -7 | | | Volts | |
| Sensitivity | | | ± 7 | Volts | |
| | | | ± 0.3 | | |

SPECIFICATIONS

$T_A = +25^\circ\text{C}$ and $V_{CC} = +4.75\text{V}$ to $+5.25\text{V}$ unless otherwise noted.

| | MIN. | TYP. | MAX. | UNITS | CONDITIONS |
|---|-------------------------|----------------|---|---|---|
| V.11 RECEIVER (continued) DC Parameters (cont.) | | | | | |
| Input Current Current w/ 100 Termination Input Impedance | -3.25 4 | | ± 3.25 ± 60.75 | mA mA k Ω | per Figure 20 and 22 per Figure 23 and 24 |
| AC Parameters | | | | | $V_{CC} = +5\text{V}$ for AC parameters |
| Propagation Delay t_{PHL} t_{PLH} | 30 30 | 65 65 | 85 85 | ns ns ns | per Figures 33 and 38; $C_L = 50\text{pF}$ per Figures 33 and 38; $C_L = 50\text{pF}$ |
| Differential Skew Max. Transmission Rate | 10 20 | | | Mbps | per Figure 33; $C_L = 50\text{pF}$ per Figure 33; $C_L = 50\text{pF}$ $f_{IN} = 10\text{MHz}$ |
| V.35 DRIVER DC Parameters | | | | | |
| Outputs Open Circuit Voltage Test Terminated Voltage Offset Source Impedance Short-Circuit Impedance | ± 0.44 50 135 | | ± 1.20 ± 0.66 ± 0.6 150 165 | Volts Volts Volts Ω Ω | per Figure 16 per Figure 25 per Figure 25 per Figure 27; $Z_S = V_2/V_1 \times 50\Omega$ per Figure 28 |
| AC Parameters | | | | | $V_{CC} = +5\text{V}$ for AC parameters |
| Outputs Transition Time Propagation Delay t_{PHL} t_{PLH} | 30 50 50 | 40 70 70 | ns ns ns | | per Figure 29; 10% to 90% |
| Differential Skew Max. Transmission Rate | 7 20 | 10 | | Mbps | per Figures 33 and 36; $C_L = 20\text{pF}$ per Figures 33 and 36; $C_L = 20\text{pF}$ per Figures 33 and 36; $C_L = 20\text{pF}$ per Figure 33; $C_L = 20\text{pF}$ $f_{IN} = 10\text{MHz}$ |
| V.35 RECEIVER DC Parameters | | | | | |
| Inputs Sensitivity Source Impedance Short-Circuit Impedance | 90 135 | ± 80 | 110 165 | mV Ω Ω | per Figure 30; $Z_S = V_2/V_1 \times 50\Omega$ per Figure 31 |
| AC Parameters | | | | | $V_{CC} = +5\text{V}$ for AC parameters |
| Propagation Delay t_{PHL} t_{PLH} | 30 30 | 75 75 | 90 90 | ns ns ns | per Figures 33 and 38; $C_L = 20\text{pF}$ per Figures 33 and 38; $C_L = 20\text{pF}$ |
| Differential Skew Max. Transmission Rate | 10 20 | | | Mbps | per Figure 33; $C_L = 20\text{pF}$ per Figure 33; $C_L = 20\text{pF}$ $f_{IN} = 10\text{MHz}$ |
| TRANSCEIVER LEAKAGE CURRENTS | | | | | |
| Driver Output 3-State Current Rcvr Output 3-State Current | | 500 1 | 10 | μA μA | per Figure 32; Drivers disabled $DEC_X = 0000, 0.4\text{V} \quad V_O = 2.4\text{V}$ |

OTHER AC CHARACTERISTICS

$T_A = +25^\circ\text{C}$ and $V_{CC} = +5.0\text{V}$ unless otherwise noted.

| PARAMETER | MIN. | TYP. | MAX. | UNITS | CONDITIONS |
|---|------|------|------|-------|---|
| DRIVER DELAY TIME BETWEEN ACTIVE MODE AND TRI-STATE MODE | | | | | |
| RS-232/V.28 | | | | | |
| t_{PZL} ; Tri-state to Output LOW | | 0.70 | 5.0 | μs | $C_L = 100\text{pF}$, Fig. 34 & 40; S_1 closed |
| t_{PZH} ; Tri-state to Output HIGH | | 0.40 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 34 & 40; S_2 closed |
| t_{PLZ} ; Output LOW to Tri-state | | 0.20 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 34 & 40; S_1 closed |
| t_{PHZ} ; Output HIGH to Tri-state | | 0.40 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 34 & 40; S_2 closed |
| RS-423/V.10 | | | | | |
| t_{PZL} ; Tri-state to Output LOW | | 0.15 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 34 & 40; S_1 closed |
| t_{PZH} ; Tri-state to Output HIGH | | 0.20 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 34 & 40; S_2 closed |
| t_{PLZ} ; Output LOW to Tri-state | | 0.20 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 34 & 40; S_1 closed |
| t_{PHZ} ; Output HIGH to Tri-state | | 0.15 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 34 & 40; S_2 closed |
| RS-422/V.11 | | | | | |
| t_{PZL} ; Tri-state to Output LOW | | 2.80 | 10.0 | μs | $C_L = 100\text{pF}$, Fig. 34 & 37; S_1 closed |
| t_{PZH} ; Tri-state to Output HIGH | | 0.10 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 34 & 37; S_2 closed |
| t_{PLZ} ; Output LOW to Tri-state | | 0.10 | 2.0 | μs | $C_L = 15\text{pF}$, Fig. 34 & 37; S_1 closed |
| t_{PHZ} ; Output HIGH to Tri-state | | 0.10 | 2.0 | μs | $C_L = 15\text{pF}$, Fig. 34 & 37; S_2 closed |
| V.35 | | | | | |
| t_{PZL} ; Tri-state to Output LOW | | 2.60 | 10.0 | μs | $C_L = 100\text{pF}$, Fig. 34 & 37; S_1 closed |
| t_{PZH} ; Tri-state to Output HIGH | | 0.10 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 34 & 37; S_2 closed |
| t_{PLZ} ; Output LOW to Tri-state | | 0.10 | 2.0 | μs | $C_L = 15\text{pF}$, Fig. 34 & 37; S_1 closed |
| t_{PHZ} ; Output HIGH to Tri-state | | 0.15 | 2.0 | μs | $C_L = 15\text{pF}$, Fig. 34 & 37; S_2 closed |
| RECEIVER DELAY TIME BETWEEN ACTIVE MODE AND TRI-STATE MODE | | | | | |
| RS-232/V.28 | | | | | |
| t_{PZL} ; Tri-state to Output LOW | | 0.12 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 35 & 38; S_1 closed |
| t_{PZH} ; Tri-state to Output HIGH | | 0.10 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 35 & 38; S_2 closed |
| t_{PLZ} ; Output LOW to Tri-state | | 0.10 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 35 & 38; S_1 closed |
| t_{PHZ} ; Output HIGH to Tri-state | | 0.10 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 35 & 38; S_2 closed |
| RS-423/V.10 | | | | | |
| t_{PZL} ; Tri-state to Output LOW | | 0.10 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 35 & 38; S_1 closed |
| t_{PZH} ; Tri-state to Output HIGH | | 0.10 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 35 & 38; S_2 closed |
| t_{PLZ} ; Output LOW to Tri-state | | 0.10 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 35 & 38; S_1 closed |
| t_{PHZ} ; Output HIGH to Tri-state | | 0.10 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 35 & 38; S_2 closed |

OTHER AC CHARACTERISTICS (Continued)

$T_A = +25^\circ\text{C}$ and $V_{CC} = +5.0\text{V}$ unless otherwise noted.

| PARAMETER | MIN. | TYP. | MAX. | UNITS | CONDITIONS |
|---|------|------|------|---------------|---|
| RS-422/V.11 | | | | | |
| t_{PZL} ; Tri-state to Output LOW | | 0.10 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 35 & 39; S_1 closed |
| t_{PZH} ; Tri-state to Output HIGH | | 0.10 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 35 & 39; S_2 closed |
| t_{PLZ} ; Output LOW to Tri-state | | 0.10 | 2.0 | μs | $C_L = 15\text{pF}$, Fig. 35 & 39; S_1 closed |
| t_{PHZ} ; Output HIGH to Tri-state | | 0.10 | 2.0 | μs | $C_L = 15\text{pF}$, Fig. 35 & 39; S_2 closed |
| V.35 | | | | | |
| t_{PZL} ; Tri-state to Output LOW | | 0.10 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 35 & 39; S_1 closed |
| t_{PZH} ; Tri-state to Output HIGH | | 0.10 | 2.0 | μs | $C_L = 100\text{pF}$, Fig. 35 & 39; S_2 closed |
| t_{PLZ} ; Output LOW to Tri-state | | 0.10 | 2.0 | μs | $C_L = 15\text{pF}$, Fig. 35 & 39; S_1 closed |
| t_{PHZ} ; Output HIGH to Tri-state | | 0.10 | 2.0 | μs | $C_L = 15\text{pF}$, Fig. 35 & 39; S_2 closed |
| TRANSCEIVER TO TRANSCEIVER SKEW (per Figures 33, 36, 38) | | | | | |
| V.28 Driver | | 100 | | ns | $[(t_{phl})_{Tx1} - (t_{phl})_{Tx6,7}]$ |
| | | 100 | | ns | $[(t_{phl})_{Tx1} - (t_{phl})_{Tx6,7}]$ |
| V.28 Receiver | | 20 | | ns | $[(t_{phl})_{Rx1} - (t_{phl})_{Rx2,7}]$ |
| | | 20 | | ns | $[(t_{phl})_{Rx1} - (t_{phl})_{Rx2,7}]$ |
| V.11 Driver | | 2 | | ns | $[(t_{phl})_{Tx1} - (t_{phl})_{Tx6,7}]$ |
| | | 2 | | ns | $[(t_{phl})_{Tx1} - (t_{phl})_{Tx6,7}]$ |
| V.11 Receiver | | 3 | | ns | $[(t_{phl})_{Rx1} - (t_{phl})_{Rx2,7}]$ |
| | | 3 | | ns | $[(t_{phl})_{Rx1} - (t_{phl})_{Rx2,7}]$ |
| V.10 Driver | | 5 | | ns | $[(t_{phl})_{Tx2} - (t_{phl})_{Tx3,4,5}]$ |
| | | 5 | | ns | $[(t_{phl})_{Tx2} - (t_{phl})_{Tx3,4,5}]$ |
| V.10 Receiver | | 5 | | ns | $[(t_{phl})_{Rx2} - (t_{phl})_{Rx3,4,5}]$ |
| | | 5 | | ns | $[(t_{phl})_{Rx2} - (t_{phl})_{Rx3,4,5}]$ |
| V.35 Driver | | 4 | | ns | $[(t_{phl})_{Tx1} - (t_{phl})_{Tx6,7}]$ |
| | | 4 | | ns | $[(t_{phl})_{Tx1} - (t_{phl})_{Tx6,7}]$ |
| V.35 Receiver | | 6 | | ns | $[(t_{phl})_{Rx1} - (t_{phl})_{Rx2,7}]$ |
| | | 6 | | ns | $[(t_{phl})_{Rx1} - (t_{phl})_{Rx2,7}]$ |

POWER REQUIREMENTS

| PARAMETER | MIN. | TYP. | MAX. | UNITS | CONDITIONS |
|---|------|-------------------------------|------|----------------------------|--|
| V_{CC} | 4.75 | 5.00 | 5.25 | Volts | |
| I_{CC} (No Mode Selected) (V.28/RS-232) (V.11/X.21) (EIA-530 & RS-449) (V.35) | | 30 65 175 250 100 | | mA mA mA mA mA | All I_{CC} values are with $V_{CC} = +5\text{V}$ $f_{IN} = 120\text{kbps}$; Drivers active & loaded. $f_{IN} = 10\text{Mbps}$; Drivers active & loaded. $f_{IN} = 10\text{Mbps}$; Drivers active & loaded. V.35 @ $f_{IN} = 10\text{Mbps}$, V.28 @ 20kbps; Drivers active & loaded. |

TEST CIRCUITS

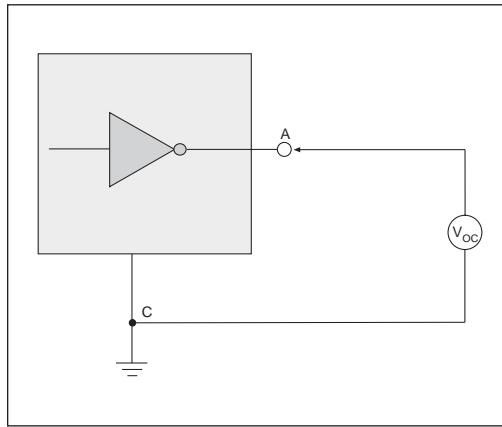


Figure 1. V.28 Driver Output Open Circuit Voltage

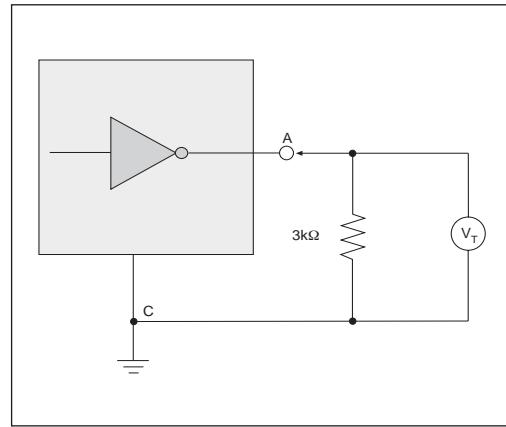


Figure 2. V.28 Driver Output Loaded Voltage

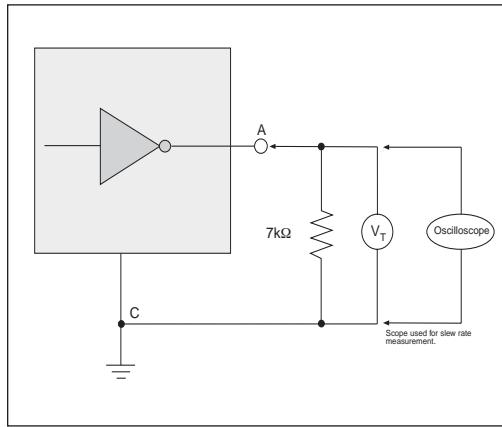


Figure 3. V.28 Driver Output Slew Rate

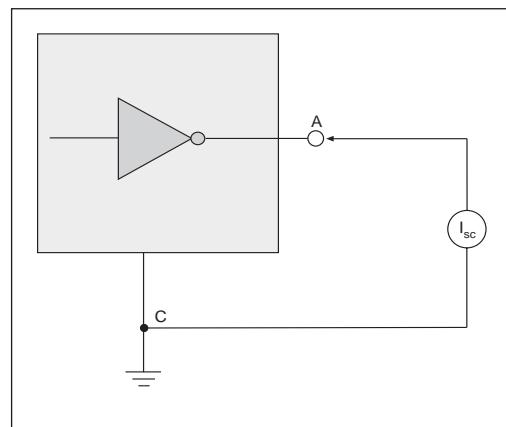


Figure 4. V.28 Driver Output Short-Circuit Current

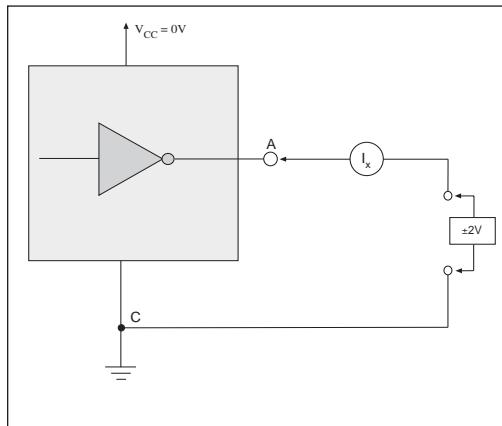


Figure 5. V.28 Driver Output Power-Off Impedance

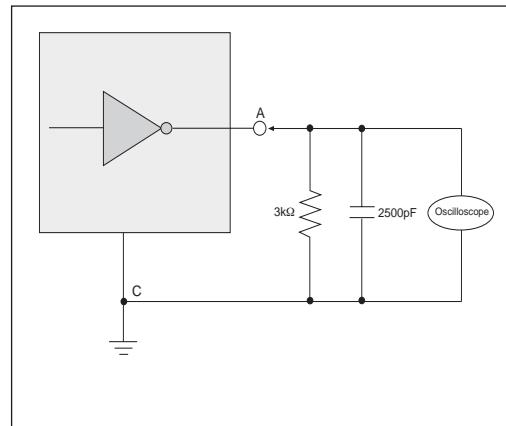


Figure 6. V.28 Driver Output Rise/Fall Times

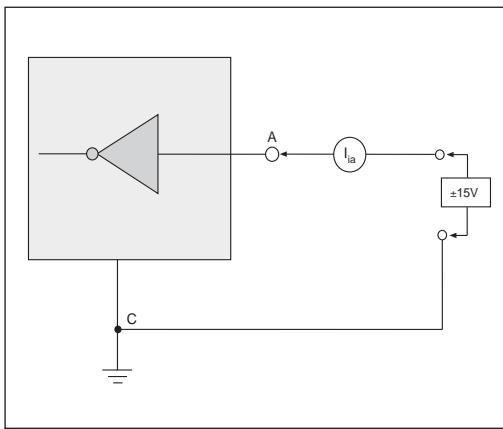


Figure 7. V.28 Receiver Input Impedance

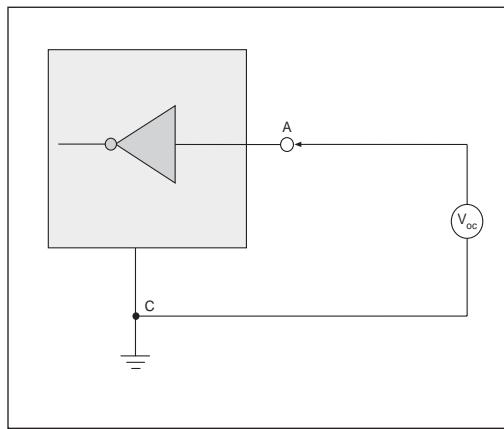


Figure 8. V.28 Receiver Input Open Circuit Bias

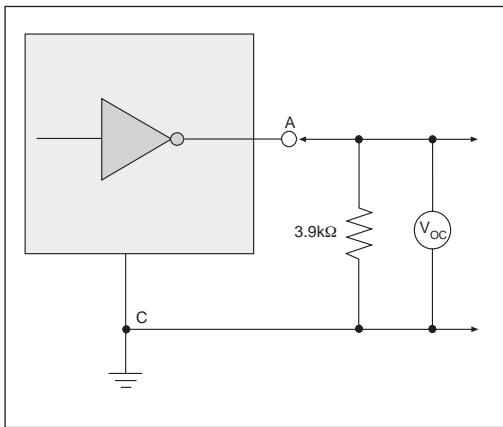


Figure 9. V.10 Driver Output Open-Circuit Voltage

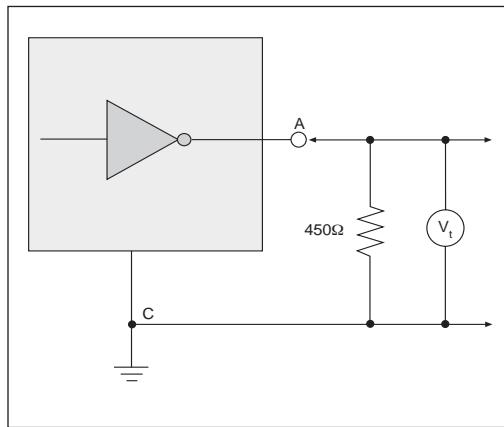


Figure 10. V.10 Driver Output Test Terminated Voltage

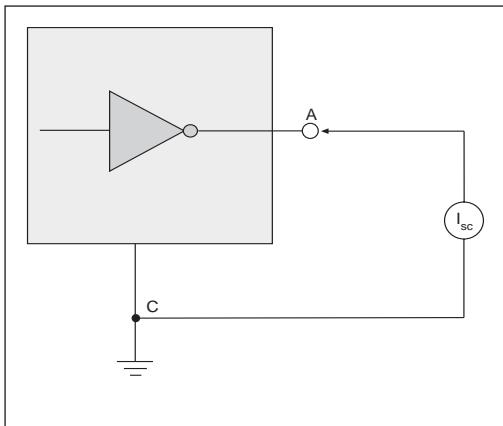


Figure 11. V.10 Driver Output Short-Circuit Current

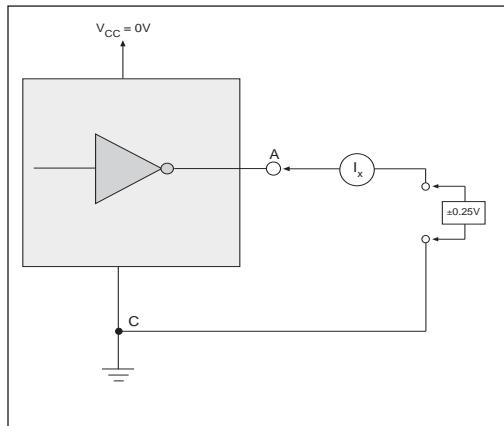


Figure 12. V.10 Driver Output Power-Off Current

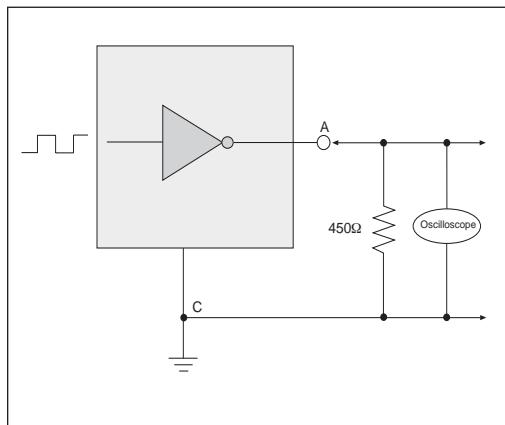


Figure 13. V.10 Driver Output Transition Time

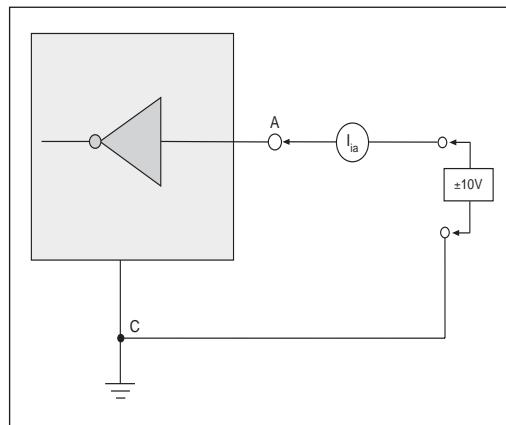


Figure 14. V.10 Receiver Input Current

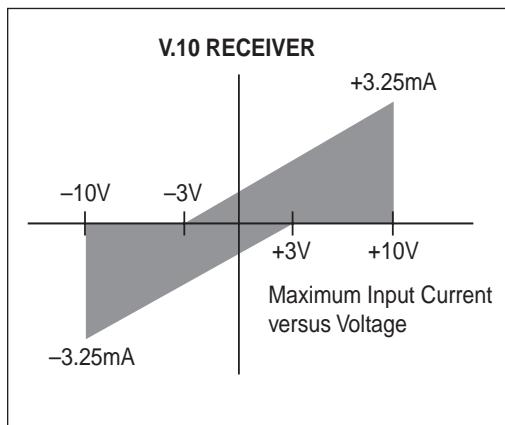


Figure 15. V.10 Receiver Input IV Graph

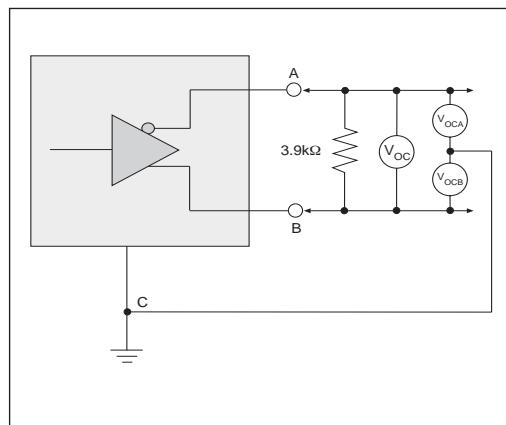


Figure 16. V.11 and V.35 Driver Output Open-Circuit Voltage

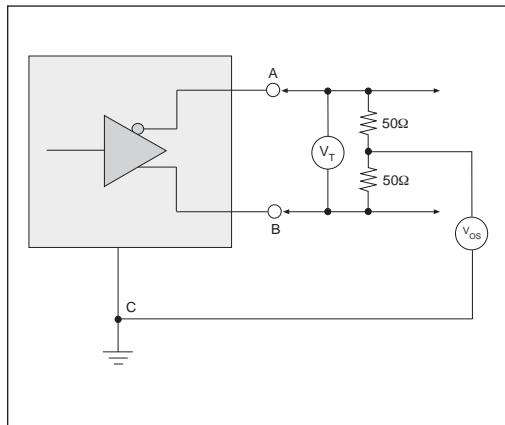


Figure 17. V.11 Driver Output Test Terminated Voltage

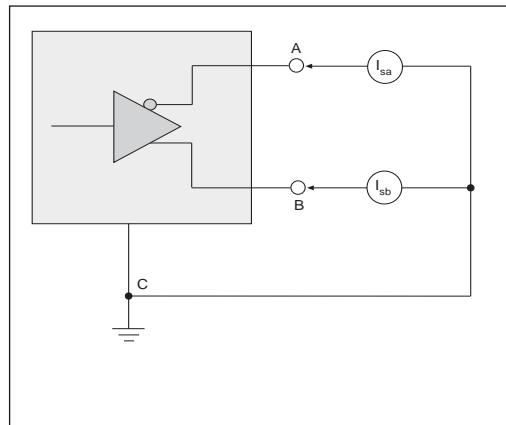


Figure 18. V.11 Driver Output Short-Circuit Current

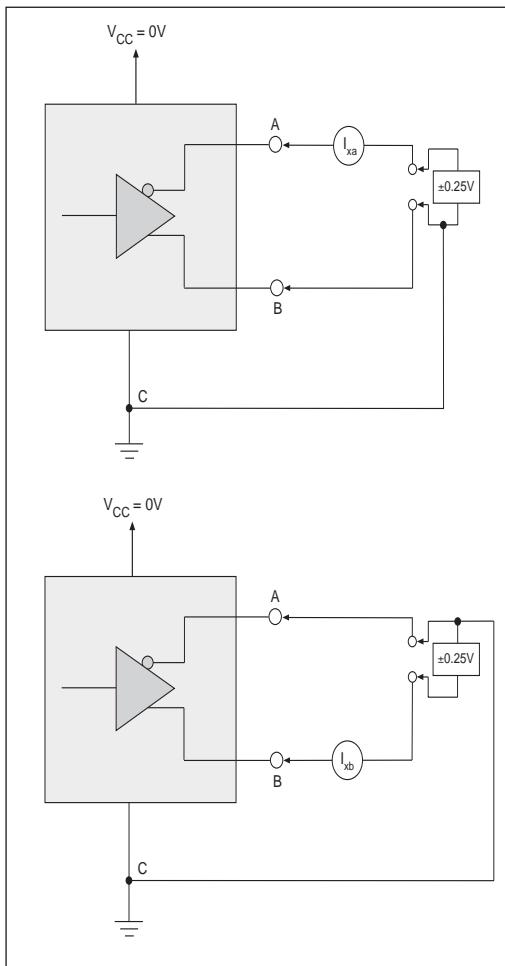


Figure 19. V.11 Driver Output Power-Off Current

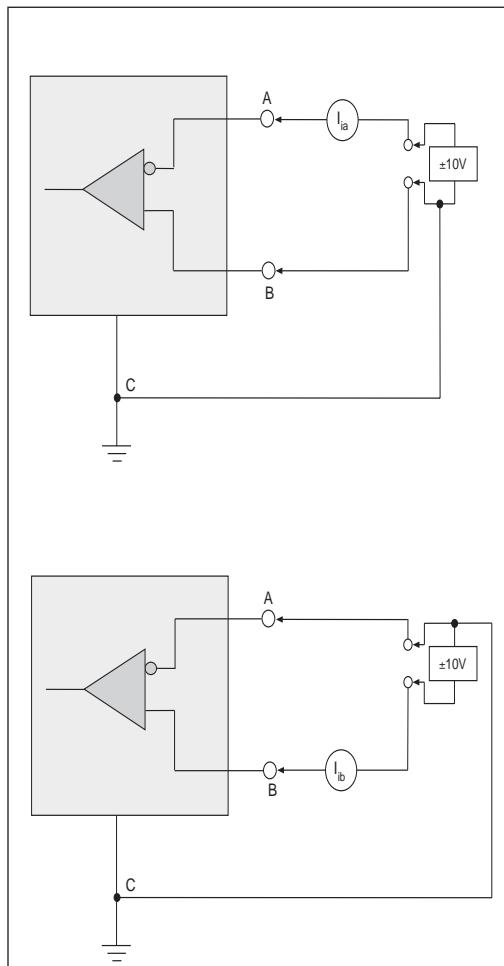


Figure 20. V.11 Receiver Input Current

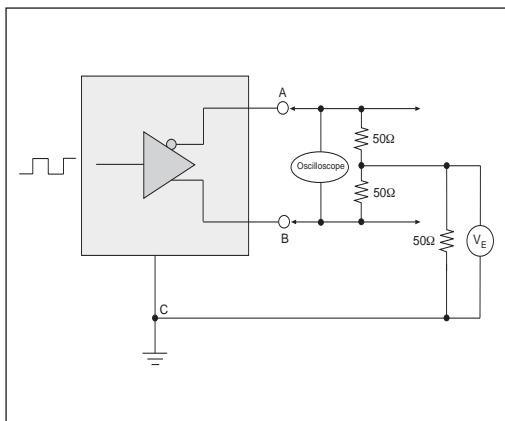


Figure 21. V.11 Driver Output Rise/Fall Time

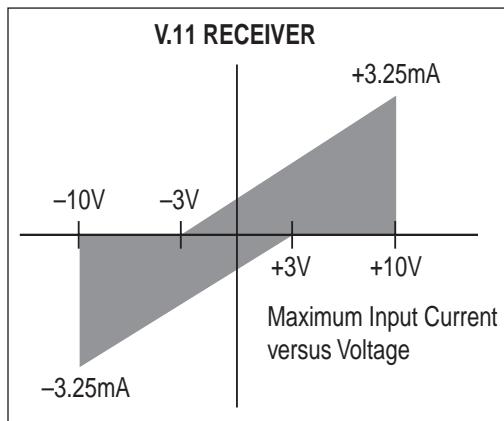


Figure 22. V.11 Receiver Input IV Graph

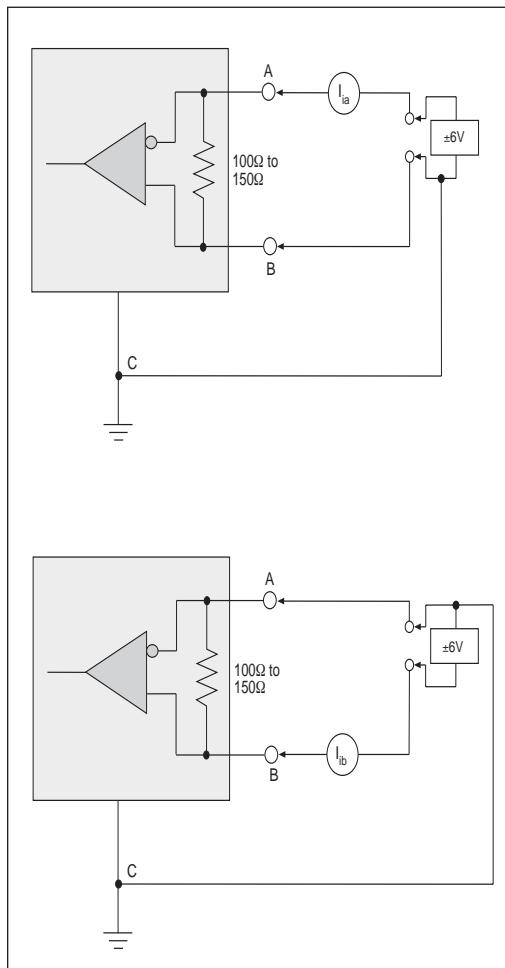


Figure 23. V.11 Receiver Input Current w/ Termination

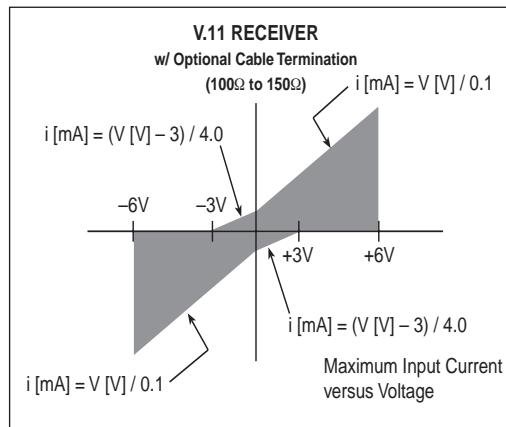


Figure 24. V.11 Receiver Input Graph w/ Termination

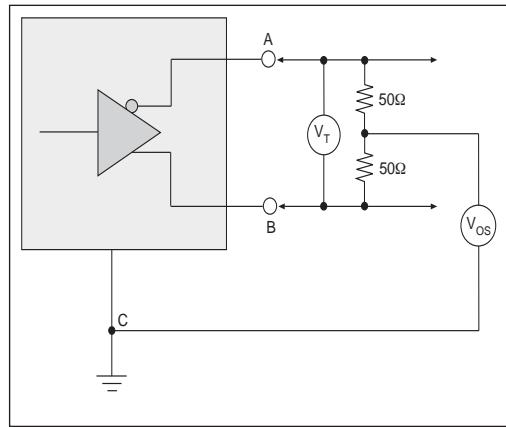


Figure 25. V.35 Driver Output Test Terminated Voltage

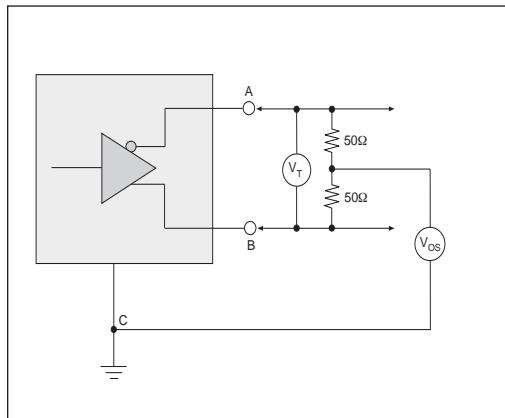


Figure 26. V.35 Driver Output Offset Voltage

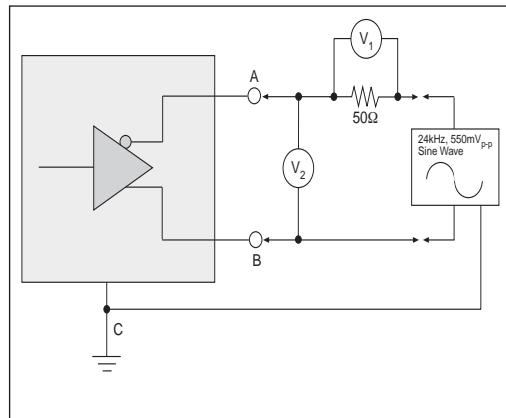


Figure 27. V.35 Driver Output Source Impedance

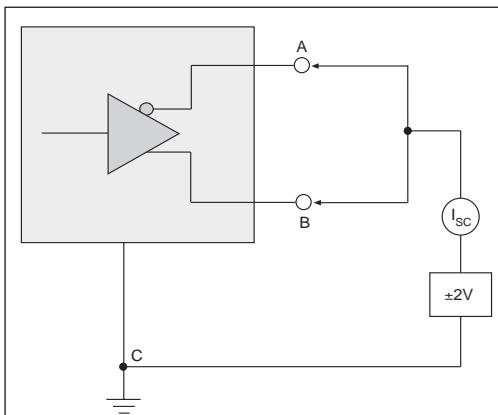


Figure 28. V.35 Driver Output Short-Circuit Impedance

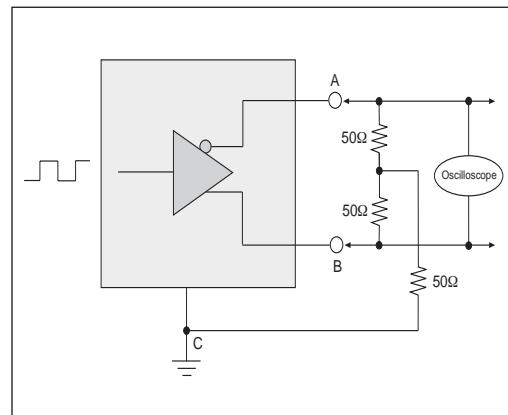


Figure 29. V.35 Driver Output Rise/Fall Time

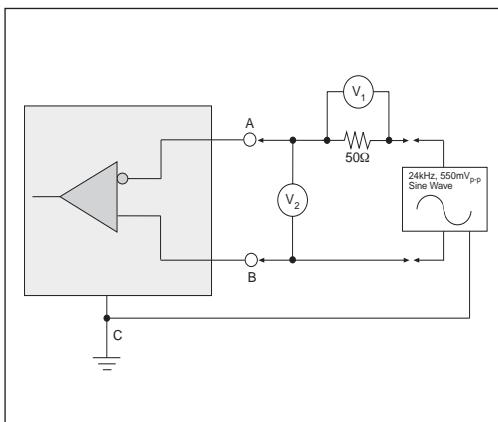


Figure 30. V.35 Receiver Input Source Impedance

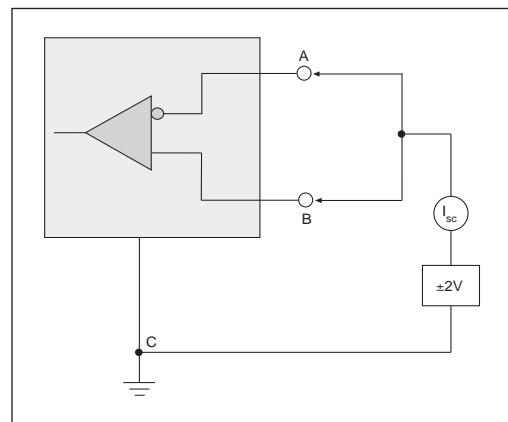


Figure 31. V.35 Receiver Input Short-Circuit Impedance

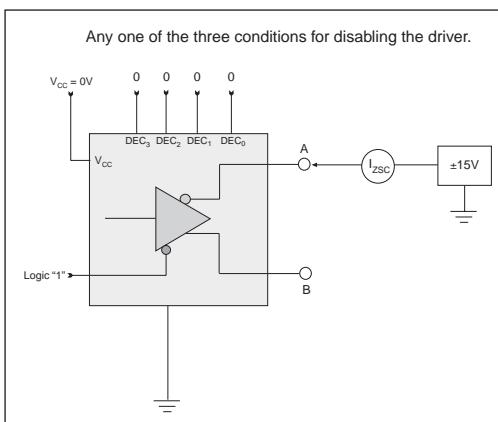


Figure 32. Driver Output Leakage Current Test

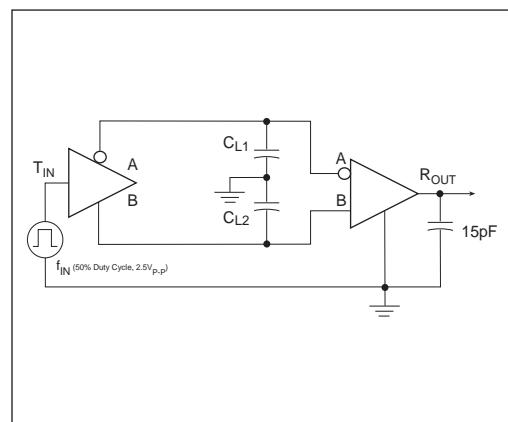


Figure 33. Driver/Receiver Timing Test Circuit

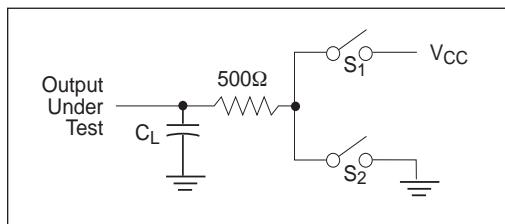


Figure 34. Driver Timing Test Load Circuit

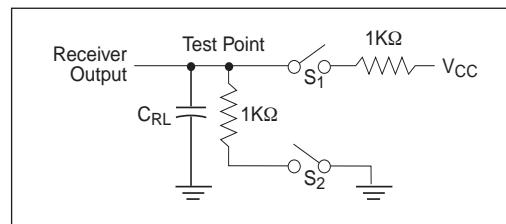


Figure 35. Receiver Timing Test Load Circuit

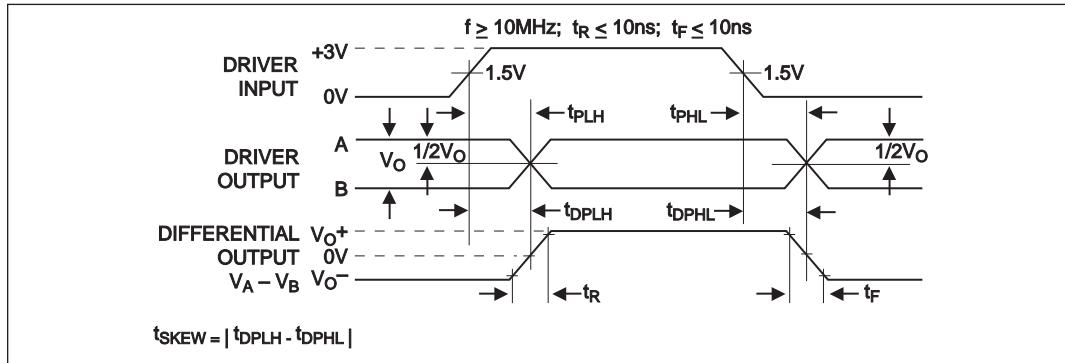


Figure 36. Driver Propagation Delays

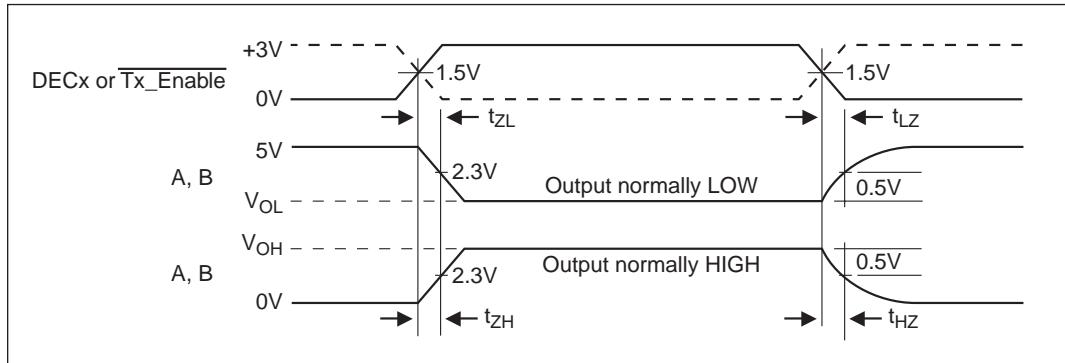


Figure 37. Driver Enable and Disable Times

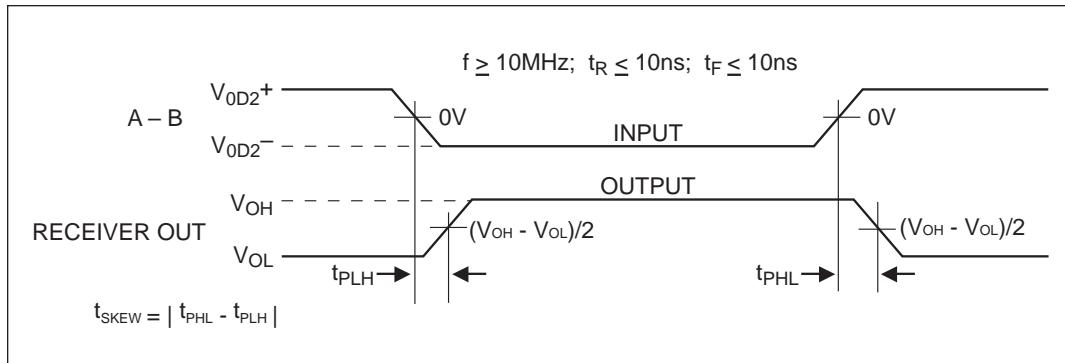


Figure 38. Receiver Propagation Delays

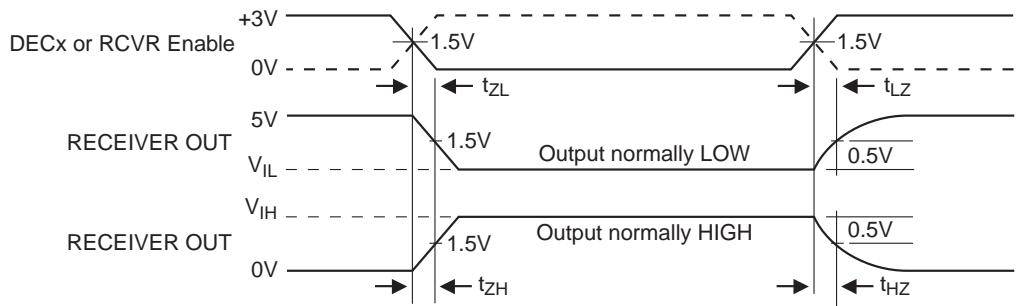


Figure 39. Receiver Enable and Disable Times

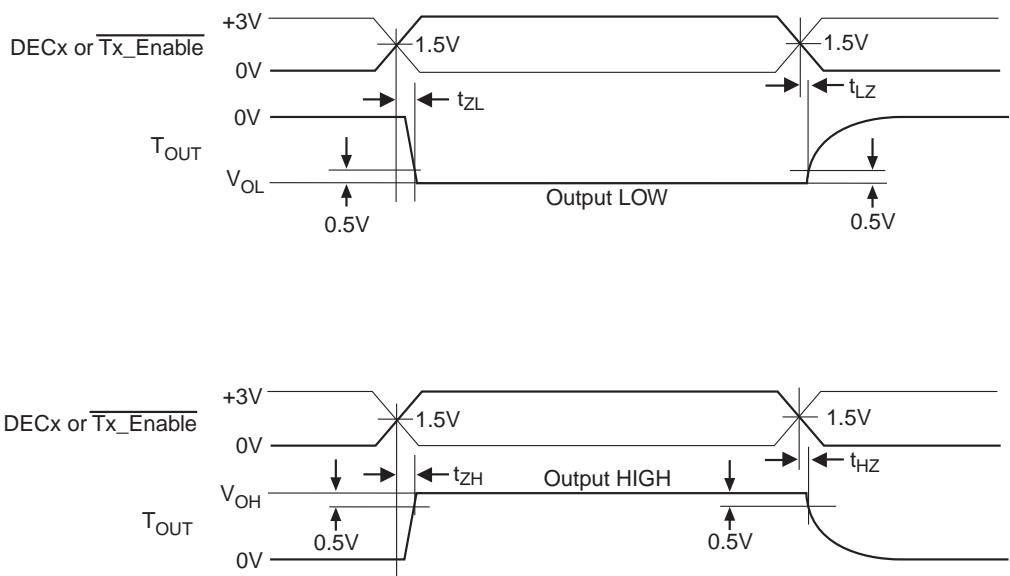


Figure 40. V.28 (RS-232) and V.10 (RS-423) Driver Enable and Disable Times

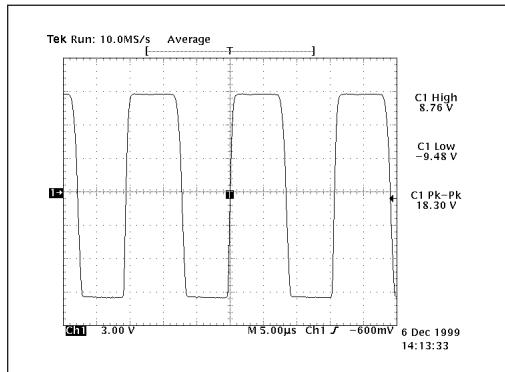


Figure 41. Typical V.28 Driver Output Waveform

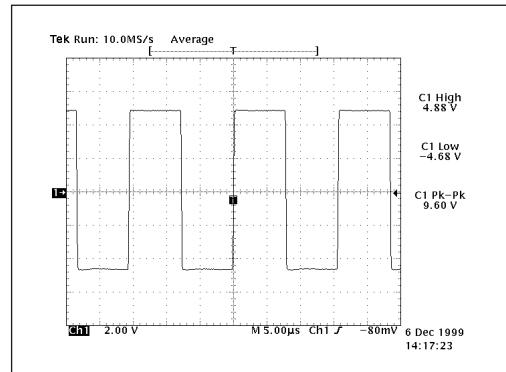


Figure 42. Typical V.10 Driver Output Waveform

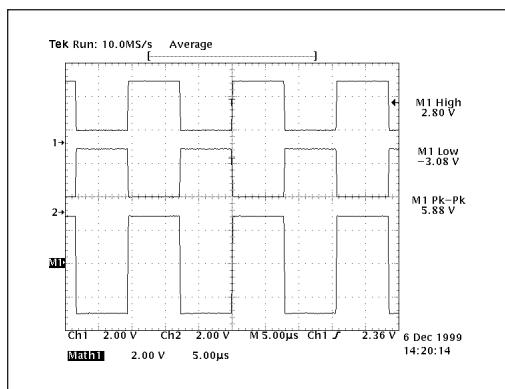


Figure 43. Typical V.11 Driver Output Waveforms

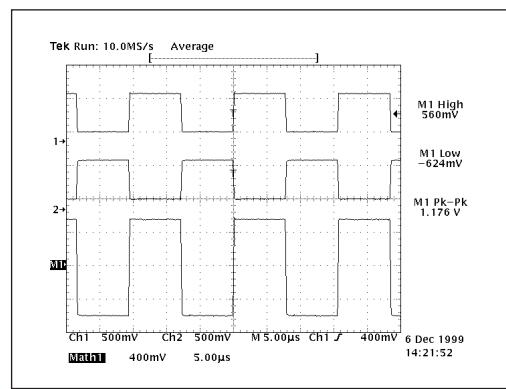
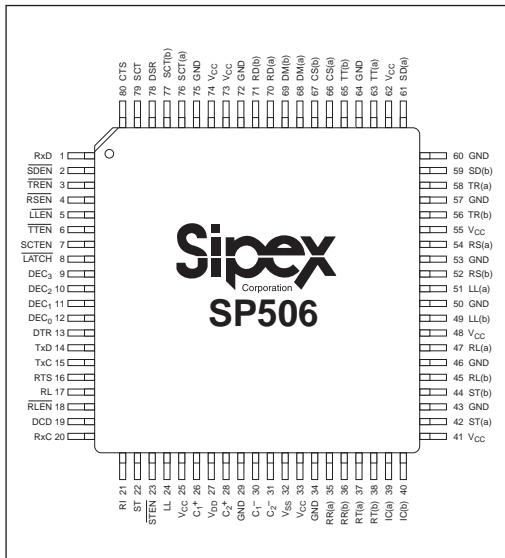


Figure 44. Typical V.35 Driver Output Waveforms

PINOUT



PIN ASSIGNMENTS

CLOCK AND DATA GROUP

Pin 1 — RxD — Receive Data; TTL output, sourced from RD(a) and RD(b) inputs.

Pin 14 — TxD — TTL input ; transmit data source for SD(a) and SD(b) outputs.

Pin 15 — TxC — Transmit Clock; TTL input for TT driver outputs.

Pin 20 — RxC — Receive Clock; TTL output sourced from RT(a) and RT(b) inputs.

Pin 22 — ST — Send Timing; TTL input; source for ST(a) and ST(b) outputs.

Pin 37 — RT(a) — Receive Timing; analog input, inverted; source for RxC.

Pin 38 — RT(b) — Receive Timing; analog input, non-inverted; source for RxC.

Pin 42 — ST(a) — Send Timing; analog output, inverted; sourced from ST.

Pin 44 — ST(b) — Send Timing; analog output, non-inverted; sourced from ST.

Pin 59 — SD(b) — Analog Out — Send data, non-inverted; sourced from TxD.

Pin 61 — SD(a) — Analog Out — Send data, inverted; sourced from TxD.

Pin 63 — TT(a) — Analog Out — Terminal Timing, inverted; sourced from TxC.

Pin 65 — TT(b) — Analog Out — Terminal Timing, non-inverted; sourced from TxC.

Pin 70 — RD(a) — Receive Data, analog input; inverted; source for RxD.

Pin 71 — RD(b) — Receive Data; analog input; non-inverted; source for RxD.

Pin 76 — SCT(a) — Serial Clock Transmit; analog input, inverted; source for SCT.

Pin 77 — SCT(b) — Serial Clock Transmit; analog input, non-inverted; source for SCT

Pin 79 — SCT — Serial Clock Transmit; TTL output; sources from SCT(a) and SCT(b) inputs.

CONTROL LINE GROUP

Pin 13 — DTR — Data Terminal Ready; TTL input; source for TR(a) and TR(b) outputs.

Pin 16 — RTS — Ready To Send; TTL input; source for RS(a) and RS(b) outputs.

Pin 17 — RL — Remote Loopback; TTL input; source for RL(a) and RL(b) outputs.

Pin 19 — DCD — Data Carrier Detect; TTL output; sourced from RR(a) and RR(b) inputs.

Pin 21 — RI — Ring In; TTL output; sourced from IC(a) and IC(b) inputs.

Pin 24 — LL — Local Loopback; TTL input; source for LL(a) and LL(b) outputs.

Pin 35 — RR(a) — Receiver Ready; analog input, inverted; source for DCD.

Pin 36 — RR(b) — Receiver Ready; analog input, non-inverted; source for DCD.

Pin 39 — IC(a) — Incoming Call; analog input, inverted; source for RI.

Pin 40 — IC(b) — Incoming Call; analog input, non-inverted; source for RI.

Pin 45 — RL(b) — Remote Loopback; analog output, non-inverted; sourced from RL.

Pin 47 — RL(a) — Remote Loopback; analog output inverted; sourced from RL.

Pin 49 — LL(b) — Local Loopback; analog output, non-inverted; sourced from LL.

Pin 51 — LL(a) — Local Loopback; analog output, inverted; sourced from LL.

Pin 52 — RS(b) — Ready To Send; analog output, non-inverted; sourced from RTS.

Pin 54 — RS(a) — Ready To Send; analog output, inverted; sourced from RTS.

Pin 56 — TR(b) — Terminal Ready; analog output, non-inverted; sourced from DTR.

Pin 58 — TR(a) — Terminal Ready; analog output, inverted; sourced from DTR.

Pin 66 — CS(a) — Clear To Send; analog input, inverted; source for CTS.

Pin 67 — CS(b) — Clear To Send; analog input, non-inverted; source for CTS.

Pin 68 — DM(a) — Data Mode; analog input, inverted; source for DSR.

Pin 69 — DM(b) — Data Mode; analog input, non-inverted; source for DSR

Pin 78 — DSR — Data Set Ready; TTL output; sourced from DM(a), DM(b) inputs.

Pin 80 — CTS — Clear To Send; TTL output; sourced from CS(a) and CS(b) inputs.

CONTROL REGISTERS

Pins 2 — SDEN — Enables TxD driver, active low; TTL input.

Pins 3 — TREN — Enables DTR driver, active low; TTL input.

Pins 4 — RSEN — Enables RTS driver, active low; TTL input.

Pins 5 — LLEN — Enables LL driver, active low; TTL input.

Pin 6 — TTEN — Enables TT driver, active low; TTL input.

Pin 7 — SCTEN — Enables SCT receiver; active high; TTL input.

Pin 8 — LATCH — Latch control for decoder bits (pins 9-12), active low. Logic high input will make decoder transparent.

Pins 12-9 — DEC₀ — DEC₃ — Transmitter and receiver decode register; configures transmitter and receiver modes; TTL inputs.

Pin 18 — RLEN — Enables RL driver; active low; TTL input.

Pin 23 — STEN — Enables ST driver; active low; TTL input.

POWER SUPPLIES

Pins 25, 33, 41, 48, 55, 62, 73, 74 — V_{CC} — +5V input.

Pins 29, 34, 43, 46, 50, 53, 57, 60, 64, 72, 75 — GND — Ground.

Pin 27 — V_{DD} +10V Charge Pump Capacitor — Connects from V_{DD} to V_{CC}. Suggested capacitor size is 22μF, 16V.

Pin 32 — V_{SS} -10V Charge Pump Capacitor — Connects from ground to V_{SS}. Suggested capacitor size is 22μF, 16V.

Pins 26 and 30 — C₁⁺ and C₁⁻ — Charge Pump Capacitor — Connects from C₁⁺ to C₁⁻. Suggested capacitor size is 22μF, 16V.

Pins 28 and 31 — C₂⁺ and C₂⁻ — Charge Pump Capacitor — Connects from C₂⁺ to C₂⁻. Suggested capacitor size is 22μF, 16V.

SP506 Driver Mode Selection

| Pin Label | Mode: | RS232 | V.35 | RS422 w/Term. | RS422 | RS449 | EIA530 | EIA-530A | V.36 |
|-------------------------------|-----------|-------|-------|---------------|-------|-------|-----------|-----------|-----------|
| $\text{DEC}_3 - \text{DEC}_0$ | 0000 | 0010 | 1110 | 0100 | 0101 | 1100 | 1101 | 1111 | 0110 |
| SD(a) | tri-state | V.28 | V.35- | V.11- | V.11- | V.11- | V.11- | V.11- | V.11- |
| SD(b) | tri-state | | V.35+ | V.11+ | V.11+ | V.11+ | V.11+ | V.11+ | V.11+ |
| TR(a) | tri-state | V.28 | V.28 | V.11- | V.11- | V.11- | V.11- | V.10 | V.10 |
| TR(b) | tri-state | | | tri-state | V.11+ | V.11+ | V.11+ | tri-state | tri-state |
| RS(a) | tri-state | V.28 | V.28 | V.11- | V.11- | V.11- | V.11- | V.11- | V.10 |
| RS(b) | tri-state | | | tri-state | V.11+ | V.11+ | V.11+ | V.11+ | tri-state |
| RL(a) | tri-state | V.28 | V.28 | V.11- | V.11- | V.10 | V.11- | V.11- | V.10 |
| RL(b) | tri-state | | | tri-state | V.11+ | V.11+ | tri-state | V.11+ | tri-state |
| LL(a) | tri-state | V.28 | V.28 | V.11- | V.11- | V.10 | V.10 | V.10 | V.10 |
| LL(b) | tri-state | | | tri-state | V.11+ | V.11+ | tri-state | tri-state | tri-state |
| ST(a) | tri-state | V.28 | V.35- | V.11- | V.11- | V.11- | V.11- | V.11- | V.11- |
| ST(b) | tri-state | | V.35+ | V.11+ | V.11+ | V.11+ | V.11+ | V.11+ | V.11+ |
| TT(a) | tri-state | V.28 | V.35- | V.11- | V.11- | V.11- | V.11- | V.11- | V.11- |
| TT(b) | tri-state | | V.35+ | V.11+ | V.11+ | V.11+ | V.11+ | V.11+ | V.11+ |

Table 1. SP506 Driver Decoder Table

SP506 Receiver Mode Selection

| Pin Label | Mode: | RS232 | V.35 | RS422 w/Term. | RS422 | RS449 | EIA530 | EIA-530A | V.36 |
|-------------------------------|--------------|-------|--------------|---|---|---|---|---|---|
| $\text{DEC}_3 - \text{DEC}_0$ | 0000 | 0010 | 1110 | 0100 | 0101 | 1100 | 1101 | 1111 | 0110 |
| RD(a) | >10kΩ to GND | V.28 | V.35- | V.11-  V.11- | V.11-  V.11- | V.11-  V.11- | V.11-  V.11- | V.11-  V.11- | V.11-  V.11- |
| RD(b) | >10kΩ to GND | | >10kΩ to GND | V.35+ | V.11+  V.11+ | V.11+  V.11+ | V.11+  V.11+ | V.11+  V.11+ | V.11+  V.11+ |
| RT(a) | >10kΩ to GND | V.28 | V.35- | V.11-  V.11- | V.11-  V.11- | V.11-  V.11- | V.11-  V.11- | V.11-  V.11- | V.11-  V.11- |
| RT(b) | >10kΩ to GND | | >10kΩ to GND | V.35+ | V.11+  V.11+ | V.11+  V.11+ | V.11+  V.11+ | V.11+  V.11+ | V.11+  V.11+ |
| CS(a) | >10kΩ to GND | V.28 | V.28 | V.11- | V.11- | V.11- | V.11- | V.11- | V.10 |
| CS(b) | >10kΩ to GND | | >10kΩ to GND | >10kΩ to GND | V.11+ | V.11+ | V.11+ | V.11+ | >10kΩ to GND |
| DM(a) | >10kΩ to GND | V.28 | V.28 | V.11- | V.11- | V.11- | V.11- | V.10 | V.10 |
| DM(b) | >10kΩ to GND | | >10kΩ to GND | >10kΩ to GND | V.11+ | V.11+ | V.11+ | V.11+ | >10kΩ to GND |
| RR(a) | >10kΩ to GND | V.28 | V.28 | V.11- | V.11- | V.11- | V.11- | V.11- | V.10 |
| RR(b) | >10kΩ to GND | | >10kΩ to GND | >10kΩ to GND | V.11+ | V.11+ | V.11+ | V.11+ | >10kΩ to GND |
| IC(a) | >10kΩ to GND | V.28 | V.28 | V.11- | V.11- | V.10 | V.10 | V.10 | V.10 |
| IC(b) | >10kΩ to GND | | >10kΩ to GND | >10kΩ to GND | V.11+ | V.11+ | >10kΩ to GND | >10kΩ to GND | >10kΩ to GND |
| SCT(a) | >10kΩ to GND | V.28 | V.35- | V.11-  V.11- | V.11-  V.11- | V.11-  V.11- | V.11-  V.11- | V.11-  V.11- | V.11-  V.11- |
| SCT(b) | >10kΩ to GND | | >12kΩ to GND | V.35+ | V.11+  V.11+ | V.11+  V.11+ | V.11+  V.11+ | V.11+  V.11+ | V.11+  V.11+ |

Table 2. SP506 Receiver Decoder Table

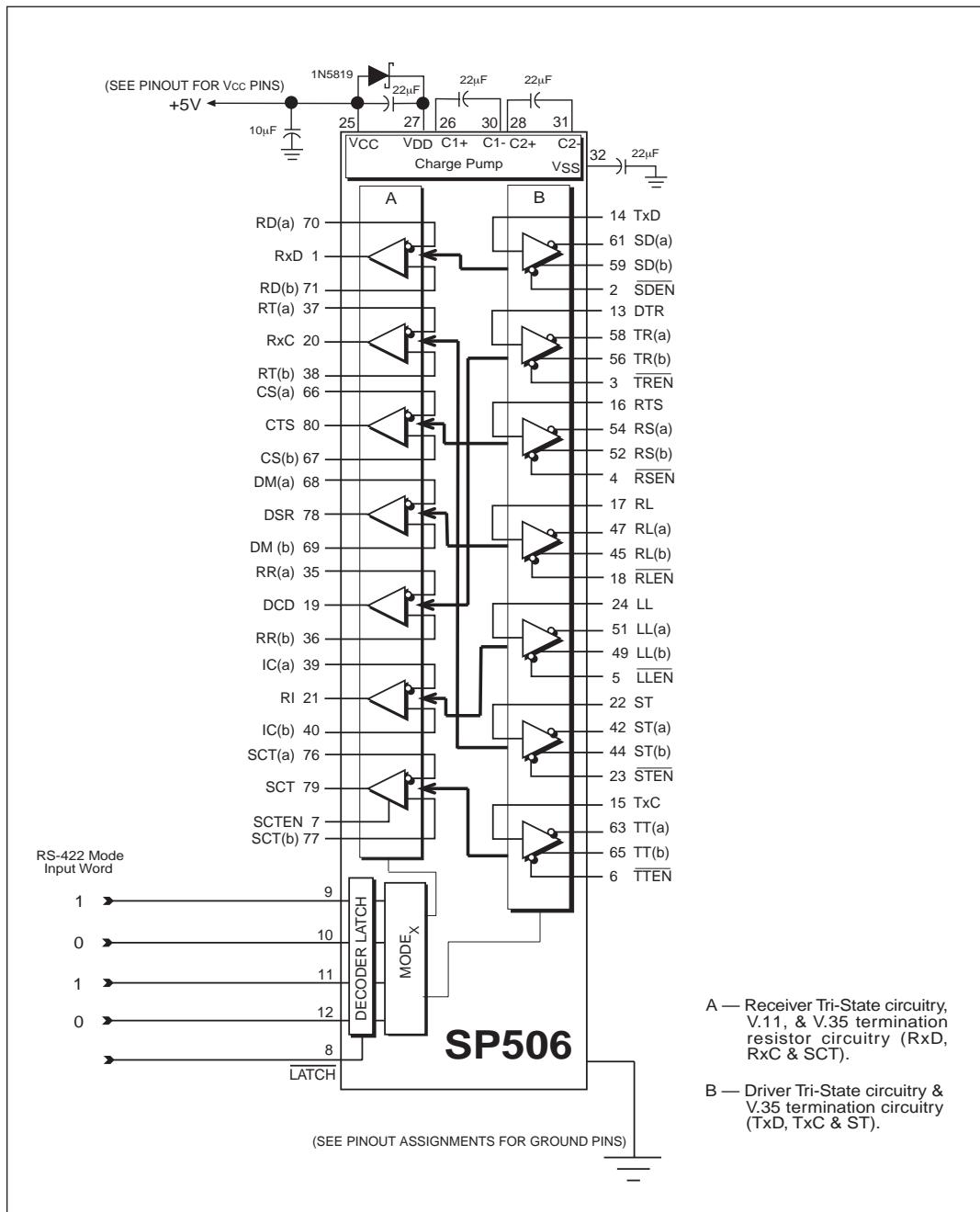
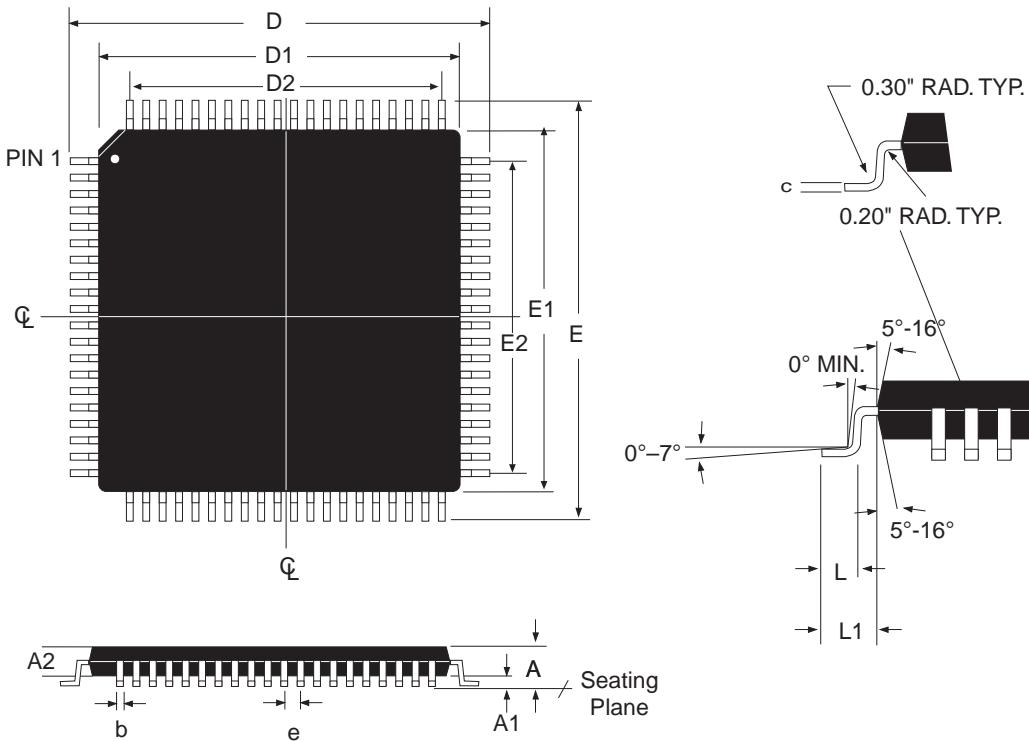


Figure 45. SP506 Typical Operating Circuit

PACKAGE: 80 PIN MQFP



| DIMENSIONS Minimum/Maximum (mm) | | 80-PIN MQFP JEDEC MS-22 (BEC) Variation | | |
|---------------------------------------|-----------|---|------|-----|
| SYMBOL | | MIN | NOM | MAX |
| A | | | 2.45 | |
| A1 | 0.00 | | 0.25 | |
| A2 | 1.80 | 2.00 | 2.20 | |
| b | 0.22 | | 0.40 | |
| D | 17.20 BSC | | | |
| D1 | 14.00 BSC | | | |
| D2 | 12.35 REF | | | |
| E | 17.20 BSC | | | |
| E1 | 14.00 BSC | | | |
| E2 | 12.35 REF | | | |
| e | 0.65 BSC | | | |
| N | 80 | | | |

| COMMON DIMENTIONS | | | |
|-------------------|------|------|------------|
| SYMBL | MIN | NOM | MAX |
| c | 0.11 | | 23.00 |
| L | 0.73 | 0.88 | 1.03 |
| L1 | | | 1.60 BASIC |

80 PIN MQFP (MS-022 BC)

ORDERING INFORMATION

| Model | Temperature Range | Package Types |
|---------|-------------------|----------------------------------|
| SP506CF | 0°C to +70°C | 80-pin JEDEC (BE-2 Outline) MQFP |

Please consult the factory for pricing and availability on a Tape-On-Reel option.

REVISION HISTORY

| DATE | REVISION | DESCRIPTION |
|---------|----------|--------------------------------|
| 1/27/04 | A | Implemented tracking revision. |
| | | |
| | | |

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